# **Dual General Purpose Transistor**

The NST3904DXV6T1G device is a spin-off of our popular SOT-23/SOT-323 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-563 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

### **Features**

- h<sub>FE</sub>, 100-300
- Low  $V_{CE(sat)}$ ,  $\leq 0.4 \text{ V}$
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- AEC-Q101 Qualified and PPAP Capable NSVT3904DXV6T1G, SNST3904DXV6T5G
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These are Pb-Free Devices

### **MAXIMUM RATINGS**

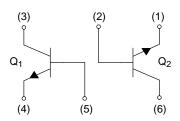
Rating		Symbol	Value	Unit
Collector - Emitter Voltage		$V_{CEO}$	40	Vdc
Collector - Base Voltage		$V_{CBO}$	60	Vdc
Emitter - Base Voltage		V <sub>EBO</sub>	6.0	Vdc
Collector Current – Continuous		I <sub>C</sub>	200	mAdc
Electrostatic Discharge	HBM MM	ESD	>16000 >2000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



### ON Semiconductor®

### www.onsemi.com



NST3904DXV6T1

### MARKING DIAGRAM



SOT-563 CASE 463A STYLE 1



MA = Device Code
M = Date Code
Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
NST3904DXV6T1G	SOT-563 (Pb-Free)	4000/Tape & Reel
NSVT3904DXV6T1G	SOT-563 (Pb-Free)	4000/Tape & Reel
NST3904DXV6T5G	SOT-563 (Pb-Free)	8000/Tape & Reel
SNST3904DXV6T5G	SOT-563 (Pb-Free)	8000/Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation T <sub>A</sub> = 25°C Derate above 25°C (Note 1)	P <sub>D</sub>	357 2.9	mW mW/°C
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{ heta JA}$	350	°C/W
Characteristic (Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation T <sub>A</sub> = 25°C Derate above 25°C (Note 1)	P <sub>D</sub>	500 4.0	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ heta JA}$	250	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

<sup>1.</sup> FR-4 @ Minimum Pad

### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characterist	ic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS		<u>.</u>			•	
Collector – Emitter Breakdown Voltage (Note 2) (I <sub>C</sub>	V <sub>(BR)CEO</sub>	40	-	Vdc		
Collector – Base Breakdown Voltage (I <sub>C</sub> = 10 μAdc	V <sub>(BR)CBO</sub>	60	-	Vdc		
Emitter-Base Breakdown Voltage ( $I_E = 10 \mu Adc, I_0$	V <sub>(BR)EBO</sub>	6.0	_	Vdc		
Base Cutoff Current ( $V_{CE} = 30 \text{ Vdc}$ , $V_{EB} = 3.0 \text{ Vdc}$	:)	I <sub>BL</sub>	_	50	nAdc	
Collector Cutoff Current (V <sub>CE</sub> = 30 Vdc, V <sub>EB</sub> = 3.0	I <sub>CEX</sub>	_	50	nAdc		
ON CHARACTERISTICS (Note 2)		<u>.</u>			•	
$\begin{array}{l} \text{DC Current Gain} \\ \text{(I}_{C} = 0.1 \text{ mAdc, V}_{CE} = 1.0 \text{ Vdc)} \\ \text{(I}_{C} = 1.0 \text{ mAdc, V}_{CE} = 1.0 \text{ Vdc)} \\ \text{(I}_{C} = 10 \text{ mAdc, V}_{CE} = 1.0 \text{ Vdc)} \\ \text{(I}_{C} = 50 \text{ mAdc, V}_{CE} = 1.0 \text{ Vdc)} \\ \text{(I}_{C} = 100 \text{ mAdc, V}_{CE} = 1.0 \text{ Vdc)} \end{array}$		h <sub>FE</sub>	40 70 100 60 30	- 300 - -	_	
	V <sub>CE(sat)</sub>	_ _	0.2 0.3	Vdc		
Base – Emitter Saturation Voltage ( $I_C = 10$ mAdc, $I_B = 1.0$ mAdc) ( $I_C = 50$ mAdc, $I_B = 5.0$ mAdc)	V <sub>BE(sat)</sub>	0.65 -	0.85 0.95	Vdc		
SMALL-SIGNAL CHARACTERISTICS		<u>.</u>		•	•	
Current-Gain - Bandwidth Product (I <sub>C</sub> = 10 mAdc	r, V <sub>CE</sub> = 20 Vdc, f = 100 MHz)	f <sub>T</sub>	300	_	MHz	
Output Capacitance ( $V_{CB} = 5.0 \text{ Vdc}$ , $I_E = 0$ , $f = 1.0$	MHz)	C <sub>obo</sub>	-	4.0	pF	
Input Capacitance ( $V_{EB} = 0.5 \text{ Vdc}$ , $I_{C} = 0$ , $f = 1.0 \text{ N}$	1Hz)	C <sub>ibo</sub>	-	8.0	pF	
Input Impedance ( $V_{CE} = 10 \text{ Vdc}$ , $I_{C} = 1.0 \text{ mAdc}$ , f =	h <sub>ie</sub>	1.0 2.0	10 12	kΩ		
Voltage Feedback Ratio ( $V_{CE} = 10 \text{ Vdc}$ , $I_{C} = 1.0 \text{ m}$	h <sub>re</sub>	0.5 0.1	8.0 10	X 10 <sup>-4</sup>		
Small – Signal Current Gain ( $V_{CE} = 10 \text{ Vdc}$ , $I_{C} = 1.0 \text{ Vdc}$	h <sub>fe</sub>	100 100	400 400	-		
Output Admittance ( $V_{CE} = 10 \text{ Vdc}$ , $I_{C} = 1.0 \text{ mAdc}$ ,	h <sub>oe</sub>	1.0 3.0	40 60	μmhos		
Noise Figure ( $V_{CE}$ = 5.0 Vdc, $I_{C}$ = 100 $\mu$ Adc, $R_{S}$ =	NF	_ _	5.0 4.0	dB		
SWITCHING CHARACTERISTICS		1		•	•	
Delay Time $(V_{CC} = 3.$	$.0 \text{ Vdc}, \text{ V}_{BE} = -0.5 \text{ Vdc})$	t <sub>d</sub>	-	35		
Rise Time (I <sub>C</sub> = 10 r	mAdc, I <sub>B1</sub> = 1.0 mAdc)	t <sub>r</sub>	-	35	ns	
Storage Time $(V_{CC} = 3.$	.0 Vdc, I <sub>C</sub> = 10 mAdc)	t <sub>s</sub>	-	200	ns	
Fall Time $(I_{B1} = I_{B2})$	= 1.0 mAdc)	t <sub>f</sub>	- 50 n			

<sup>2.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s; Duty Cycle  $\leq$  2.0%.

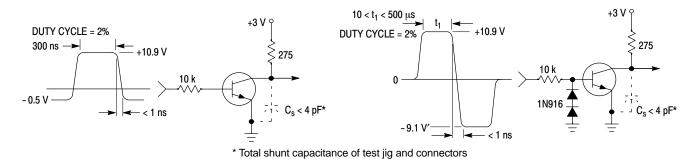


Figure 1. Delay and Rise Time Equivalent Test Circuit

Figure 2. Storage and Fall Time Equivalent Test Circuit

### TYPICAL TRANSIENT CHARACTERISTICS

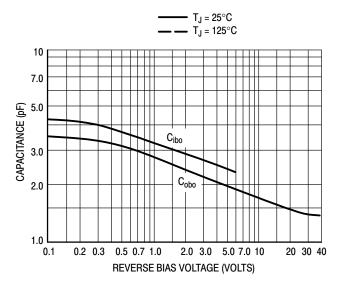


Figure 3. Capacitance

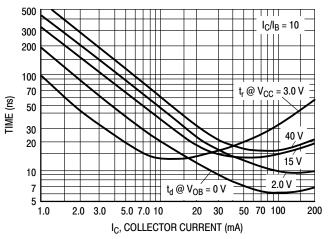


Figure 4. Turn-On Time

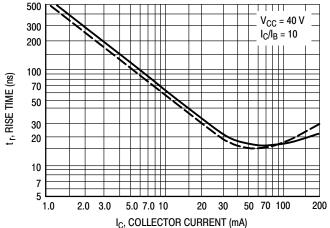


Figure 5. Rise Time

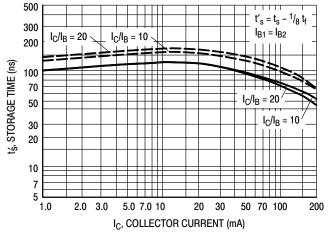


Figure 6. Storage Time

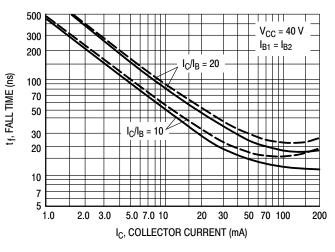
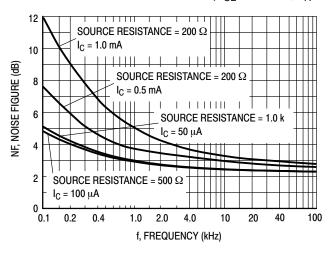


Figure 7. Fall Time

# TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE VARIATIONS

 $(V_{CE} = 5.0 \text{ Vdc}, T_A = 25^{\circ}\text{C}, Bandwidth = 1.0 \text{ Hz})$ 



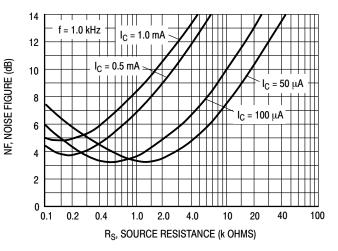
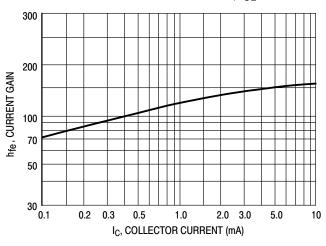


Figure 8. Noise Figure

Figure 9. Noise Figure

### h PARAMETERS

 $(V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^{\circ}\text{C})$ 



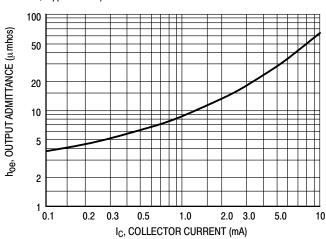


Figure 10. Current Gain

Figure 11. Output Admittance

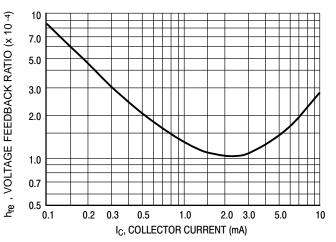


Figure 12. Input Impedance

Figure 13. Voltage Feedback Ratio

### TYPICAL STATIC CHARACTERISTICS

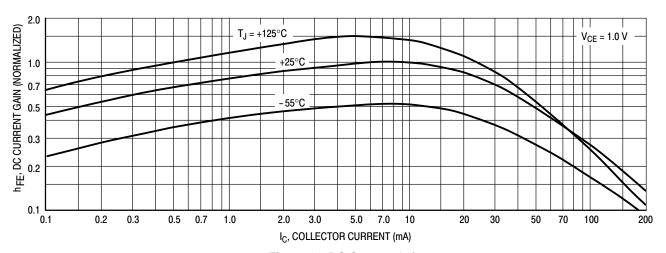


Figure 14. DC Current Gain

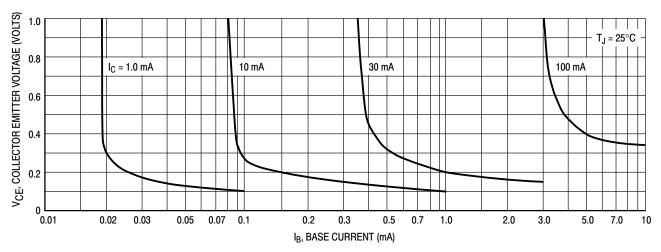


Figure 15. Collector Saturation Region

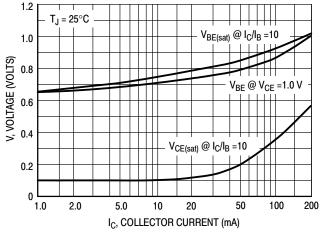
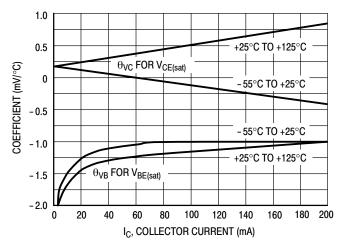


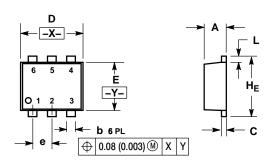
Figure 16. "ON" Voltages



**Figure 17. Temperature Coefficients** 

### PACKAGE DIMENSIONS

**SOT-563, 6 LEAD** CASE 463A ISSUE F



#### NOTES

- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

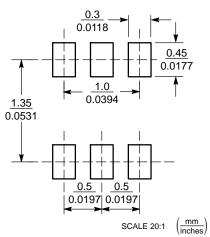
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.50	0.55	0.60	0.020	0.021	0.023
b	0.17	0.22	0.27	0.007	0.009	0.011
С	0.08	0.12	0.18	0.003	0.005	0.007
D	1.50	1.60	1.70	0.059	0.062	0.066
E	1.10	1.20	1.30	0.043	0.047	0.051
е	0.5 BSC			(	0.02 BS0	
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	1.50	1.60	1.70	0.059	0.062	0.066

### STYLE 1:

PIN 1. EMITTER 1

- 2. BASE 1 3. COLLECTOR 2
- 4. EMITTER 2
- 5 BASE 2 COLLECTOR 1

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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